#### The Fast Tracker real time processor and its impact on the muon isolation, tau & b jet online selections at Atlas



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Efficient selection of b, τ, μ, e: to be efficient on "light" particles (W, Z, H....) in terrific pileup

- Why FTK? Timing and Event complexity @High Luminosity
- Physics case: stiff-leptons, b-jets, tau-jets
- > FTK architecture



### L1-L2 early tracking: a tough problem

#### 30 minimum bias events + H->ZZ->4 $\mu$

@LHC (both CMS & Atlas) tracking is missing @L1 and late @L2







### FTK extremely important @ High Luminosity Timing



#### Why L1-L2 early TRACKING is IMPORTANT?

The most **STANDARD STIFF LEPTON TRIGGERS** based on **ISOLATION** have problems at very high pile-up

The calorimeter tower integrates energy from all the particles, also from Pileup!

We want **ISOLATION** from **HARD SCATTERING** not from **Pileup**!

Lepton identification: primary vertices fast identification  $\rightarrow$  Isolation with tracks of Pt>Th and from right vertex

Tracking more stable than calorimetric isolation against pile-up!

#### Why FTK is IMPORTANT? Stiff Muon isolation



#### Why Online Tracking is IMPORTANT? Hadronic Taus





leading  $P_T$  track in Ri (Ri=0,35 around jet axis)  $P_T > 6$  GeV

Rsig = 0,13 & Riso=0,26 around leading track;

1 (1-prong) or 2-3 (3-prong) tracks in Rsig; no tracks with Pt above 1.5 GeV in Riso.

#### Efficiency on Jets: FAKES for Had Tau selection





### Why FTK is IMPORTANT? Online b-tag @ATLAS



### Signed D0 significance Likelihood tagging performance



Offline is more stable than FTK when luminosity increases but FTK results are interesting

The CPU time freed for the tracking can be used to implement more complex algorithms like secondary-vertexing



### FTK: Architecture





### Conclusions

- Having high-quality global tracking at the start of level-2 processing can make a significant contribution to the trigger expecially at 3×10<sup>34</sup>
- We have a preliminary design that can handle the data flow at that luminosity, will take less than 100 µs/event, gives excellent physics performance, and is affordable.
- There is an implementation plan that can start to help ATLAS early.

# BACKUP



Goal: High Lum 8  $\phi$  sectors  $\longrightarrow$  8 9U VME crates for the FTK core

NOTE: The "core FTK" crates do not include the DATA Formatter boards, receiving and Formatting the detector hits

All 11 silicon layers are necessary to reduce fakes at 10<sup>34</sup> cm<sup>-1</sup> s<sup>-1</sup> & more

Overlaps require hits in a small region to be sent to two neighboring AMs Capability of the system to increase the computing power for increasing instant Luminosity or unpredicted background:

- Possible increase of phi sector number  $\rightarrow$  more overlaps, more crates
- 2. Introduction of new algorithms better tuning of existing system
- 3. Technology advancement: denser AM chips, more powerful FPGAs, links....

### Where could we insert FTK?





The Associative Memory - AM

Dedicated device - maximum parallelism:

· Each pattern with private comparator

· Track search during detector readout



Full custor 700 nm: 0,128 6L kpattern/chip
FPGA 350 nm: 0,128 6L kpattern/chip
standard ce 180 nm: 5,0 6L kpattern/chip
new for FTK 90 nm: ~25 8L kpattern/chip
90 nm 2,5 D: 50 8L kpattern/chip

### A schematic drawing of the AM



# Which banks we would like to have



What we have now: Standard Cell 180 μm pattern/chip for 6-layer patterns, 2500 pattern/chip for 12-layer patterns

"A VLSI Processor for Fast Track Finding Based on Content Addressable Memories",

**IEEE Transactions on Nuclear Science**, Volume

53, Issue 4, Part 2, Aug. 2006 Page(s):2428 - 2433

**90 nm** technology provides a factor  $4 \rightarrow 10000$  patterns/chip Full custom cell provides at least a factor  $2 \rightarrow 20000$  patterns/chip

8 layers instead of 12 provides a factor  $1,5 \rightarrow 30000$  patterns/chip



 $1,5 \times 1,5 \text{ cm}^{*2} 2D \text{ chip} = 2 \text{ Tiers} 1 \times 1 \text{ cm}^{*2} \rightarrow 60000 \text{ patterns/chip}$ With a 2 D chip we gain a factor 25! 1 AMboard: 128 chips  $\rightarrow \sim 8$  Mpatterns per board **1 Crate:** 16 AMboard  $\rightarrow$  128 Mpatterns per crate If 2 Tiers of 1,5x1,5 or 4 Tiers  $1x1 \rightarrow 256$  Mpatterns per crate With a 2 Tier - 2.5 D chip we gain a factor 50! **100 MHz** running clock

## The CDF final AMchip architecture





We are working (L.Sartori, Pisa+ M.Beretta, E. Bossini, Frascati) at the 2010 mini-asic prototype provided of full custom cell (M. Beretta Frascati) with 2 main goals:

- **Area reduction to obtain higher pattern densities**
- 2. Power consumption reduction to be able to use large silicon areas

Pattern Density/power with respect the CDF chip:

•

- 90 nm against 180 nm  $\rightarrow$  factor ~4 for area and power consumption reduction (V<sub>90</sub>/V<sub>180</sub>)\*\*2
- Full custom cell: a factor 2 gain for both area and consumption.

## Future collaboration with Fermilab to stack 2 or 4 tiers with 2.5 D technology

### **FTK @ Low - Intermediate Luminosity?**

- It is a very important Hardware & Physics test before 10<sup>34</sup> & 3x10<sup>34</sup>; test on real conditions of the detector; large impact on the whole trigger. Study of "minimum bias" b-tag and tau-tag trigger (Z0→bb, tau-tau+QCD backg). Level-2 and Event Filter algorithms in CPUs have to take into account new track availability at L2 start.
- Level-1 has to be re-studied also for Phase 1. Global Level-1 is going to be designed for Phase 1. Influence of FTK experience on real data.
- Availability of new phase space regions, like enlargement of phase space for "Hadronic Channels". This is not included in the LHC baseline trigger, neither in CMS neither in Atlas. There could be a new interest in Atlas in this area.

# Binary search to go down to better SS resolutions



#### Staging

- Start late this year to assemble a vertical slice in a test stand:
  - Use existing boards (EDRO board from SLIM5 & AM board)
  - Cover a small projective wedge in the detector
  - Develop the code needed for interaction with ATLAS TDAQ
  - Test new prototype boards as they are produced
  - Connect to the detector when test stand works & dual-output HOLAs are available.
- Install all dual-output HOLAs during 2012 shutdown
- Assemble a system using the existing AM chip adequate for a few × 10<sup>33</sup>.
- Expand the system for 1×10<sup>34</sup>.
- Replace AM chips (& LAMBs) for 3×10<sup>34</sup>.



**DATA FORMATTER** 

input S-links

From

RODs

Output

to 1 or 2

n towers

### New cleanup functions against Ghost RoadWarriors - HitWarrior

Nuclear Science, IEEE Transactions on: **The "Road Warrior" for the CDF online silicon vertex tracker** Volume 53, Issue 2, April 2006 Page(s):648 - 652

RW works on SS before knowing the fit chi\*\*2 It deletes ghosts acting on roads that differ ONLY for

a single **EMPTY** 55

Empty

SSs

RW reduces fits to be done HW works on hits after the fits so can choose the best COMBLING AIDE!tracks if they share N Hits HW is very efficient deleting ghosts The fit chi\*\*2 or more complex criteria can discriminates







<u>Physics case for  $\tau$ -jet samples</u>: one example is VBF Hqq  $\rightarrow \tau_h \tau_h qq$ 

ATLFAST (9.0.4) 6 signal events and 4 bg events in 30 fb<sup>-1</sup> ( bg : Z+jets,ttbar,QCD dijets) with baseline trigger menu tau35i+XE45 foreseen for a luminosity of  $2*10^{33}$  cm<sup>-2</sup>s<sup>-1</sup>



Promising channel that will profit a lot of a L2 fast track recontruction to keep low the trigger thresholds (35 GeV taus)

### $bbH/A \rightarrow bbbb$



ATLAS + FTK triggers		
LVL1	LVL2	Effic.
soft µ + 2j	3 b-tag	8%
3j + ΣE <sub>τ</sub> 200	3b leading	13%

As efficient as offline selection: full Higgs sensitivity





### LHC SM Higgs Discovery Potential



- Sensitivity best at  $m_{H}$ =160 GeV/c<sup>2</sup>:
  - Observation possible with ~1 fb<sup>-1</sup> (or improvement of Tevatron limits)
- Much more difficult at low mass (preferred region)
  - Need at least 10 fb<sup>-1</sup> to cover full mass range

### Bank generated with Athena fully simulated single muons



Coverage = # evts with (11 hits/11 layers) / # evts Efficiency = # evts with (11/11) OR (10/11) / # evts

**EFFICIENCY** allows for a missing LAYER (majority). Blue arrow shows a bank using less majority

### The effect of cleanup for banks of different coverage



<#roads>=10.6
<roads>=2.15 (-80%)
<nfits>= 2.2

sec>=4.54<Cross-sec>=2.27 (-50%)<tracks>=1.51

<<u>In-sec>=5.72</u>Cross-sec>=2.29 (-60%)<<u>tracks>=1.51</u>

Richer banks produce much more ghosts

G. Volpi (Pisa)